# Gallium Nitride 28V 30W, 2-6GHz RF Power Transistor

### **Description**

The NU5904H is a 30W 28V GaN HEMT, implemented with patented match topology at both input and output side, enable extremely wideband applications with frequencies from 2 to 6GHz. It can support CW, and pulse or any modulation format.

There is no guarantee of performance when this part is used in applications designed Outside of these frequencies.

### NU5904H



•Typical performance (on Innogration wide band fixture with device soldered)

Freq(MHz)	Pin(dBm)	Psat(dBm)	Psat(W)	Ids(A)	Gain(dB)	Eff(%)
1400	37.56	45.64	36.6	2.71	8.1	49.1
1600	39.44	46.17	41.4	2.80	6.7	53.5
1800	38.01	45.91	39.0	2.88	7.9	48.9
2000	37.72	45.22	33.3	2.11	7.5	58.7
2200	39.51	45.90	38.9	2.48	6.4	57.4
2400	40.17	46.30	42.7	2.87	6.1	53.7
2600	40.05	46.10	40.7	2.81	6.1	52.4
2800	40.06	45.94	39.3	2.88	5.9	49.2
3000	38.51	46.35	43.2	3.00	7.8	51.7
3200	38.06	45.80	38.0	3.00	7.7	45.6
3400	37.94	45.61	36.4	2.94	7.7	44.6
3600	37.53	45.27	33.7	3.11	7.7	38.8
3800	39.49	45.71	37.2	4.21	6.2	31.1
4000	39.54	46.42	43.9	4.32	6.9	35.7
4200	39.38	46.38	43.5	4.10	7.0	37.3
4400	38.25	46.07	40.5	3.89	7.8	36.7
4600	37.93	46.01	39.9	3.97	8.1	35.5
4800	37.75	45.95	39.4	3.90	8.2	35.6
5000	37.40	45.94	39.3	3.87	8.5	35.9
5200	36.89	45.57	36.1	3.76	8.7	34.0
5400	37.42	45.50	35.5	3.80	8.1	33.0
5600	37.50	46.42	43.9	3.75	8.9	41.4
5800	38.28	45.95	39.4	3.32	7.7	42.3
6000	39.16	45.30	33.9	3.09	6.1	39.4

Note: Data for extended 1-6GHz upon request, resulting lower output power

# **NU5904H GaN TRANSISTOR**

Document Number: NU5904H Preliminary Datasheet V1.0

#### **Applications and Features**

- Suitable for wireless communication infrastructure, wideband amplifier, EMC testing, ISM etc.
- High Efficiency and Linear Gain Operations
- Thermally Enhanced Industry Standard Package
- High Reliability Metallization Process
- · Excellent thermal Stability and Excellent Ruggedness
- Compliant to Restriction of Hazardous Substances (RoHS) Directive 2002/95/EC

#### **Important Note: Proper Biasing Sequence for GaN HEMT Transistors**

#### **Turning the device ON**

- 1. Set VGS to the pinch--off (VP) voltage, typically -5 V
- 2. Turn on VDS to nominal supply voltage (28V)
- 3. Increase VGS until IDS current is attained
- 4. Apply RF input power to desired level

### Turning the device OFF

- 1. Turn RF power off
- 2. Reduce VGS down to VP, typically -5 V
- 3. Reduce VDS down to 0 V
- 4. Turn off VGS

Table 1. Maximum Ratings (Not simultaneous, TC = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
DrainSource Voltage	V <sub>DSS</sub>	150	Vdc
GateSource Voltage	V <sub>GS</sub>	-10,+2	Vdc
Operating Voltage	V <sub>DD</sub>	32	Vdc
Maximum Forward Gate Current	Igmax	10.8	mA
Storage Temperature Range	Tstg	-65 to +150	°C
Case Operating Temperature	Tc	+150	°C
Operating Junction Temperature(See note 1)	TJ	+225	°C

#### 1. Continuous operation at maximum junction temperature will affect MTTF

#### **Table 2. Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case	Rejc-dc	2.2	°C /\M
T <sub>C</sub> = 85°C, T <sub>J</sub> =200°C,FEA	K⊕JC-DC	2.2	°C/W

#### Table 3. Electrical Characteristics (T<sub>C</sub> = 25°C unless otherwise noted)

#### **DC Characteristics**

Characteristic	Conditions	Symbol	Min	Тур	Max	Unit
Drain-Source Breakdown Voltage	V <sub>GS</sub> =-8V; I <sub>DS</sub> =10.8mA	V <sub>DSS</sub>	150			V
Gate Threshold Voltage	V <sub>DS</sub> = 28V, I <sub>D</sub> =10.8mA	V <sub>GS</sub> (th)		-2.7		V
Gate Quiescent Voltage	V <sub>DS</sub> =28V, I <sub>DS</sub> =160mA, Measured in Functional Test	V <sub>GS(Q)</sub>		-2.47		V

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# **Reference Circuit of Test Fixture Assembly Diagram**

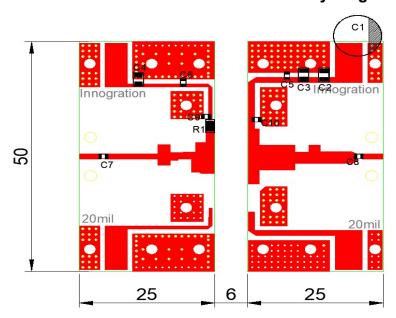
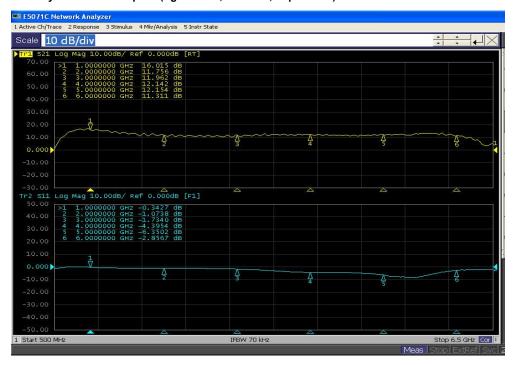


Figure 1. Test Circuit Component Layout (1.5-6GHz)

**Table 4. Test Circuit Component Designations and Values** 

Component	Description	Suggestion
C1	4700uF/63V	
C2,C3,C4	10uF	1210
C9,C10	100pF	0805
C5,C6,C7,C8	5.6pF	0805
R1	Chip Resistor,9.1Ω	1206
PCB	20mil Rogers 4350B	

Figure 2. Network Analyzer S11/S21 output (Vgs=-2.41V, Vds=28V, Idq=210mA)



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# **Package Outline**

## Flanged ceramic package; 2 leads

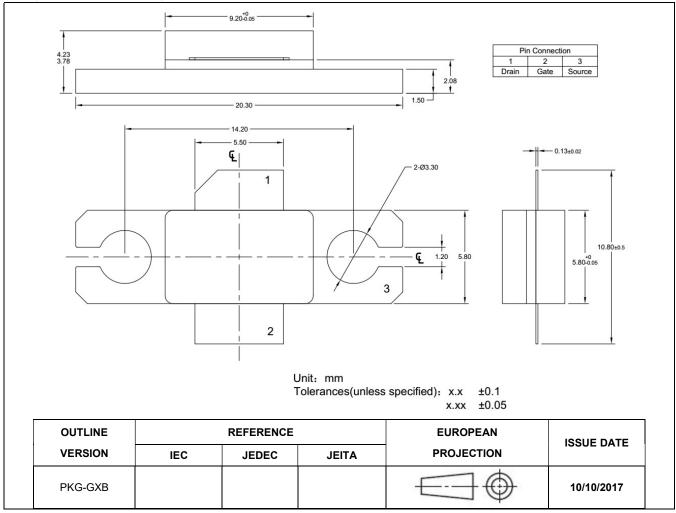


Figure 1. Package Outline PKG-G2E

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## **Revision history**

#### Table 5. Document revision history

Date	Revision	Datasheet Status
2023/1/6	V1.0	Preliminary datasheet creation, GTAH58040GX renamed to NU5904H

Application data based on RXT-23-01

#### **Notice**

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